

Product Specifications

Part Number ⁵	OCL ¹ (μH) ±30%	I _{rms} ² (A)	I _{pk} ³ (A)	DCR (mΩ) typical @ 20°C	DCR (mΩ) maximum @ 20°C	K-factor ⁴
DR1050-R80-R	0.70	9.70	13.5	3.2	4.0	20.47
DR1050-1R5-R	1.37	8.60	10.5	4.0	5.0	14.62
DR1050-2R2-R	2.27	7.52	9.3	5.6	6.8	11.37
DR1050-3R3-R	3.21	6.50	8.2	8.0	10	9.30
DR1050-4R7-R	4.43	6.13	6.7	10	12	7.87
DR1050-6R8-R	6.30	5.45	5.8	13	17	6.82
DR1050-8R2-R	8.09	5.24	5.0	15	19	6.02
DR1050-100-R	10.1	4.80	4.6	18	23	5.39
DR1050-120-R	11.6	3.94	4.1	24	30	4.87
DR1050-150-R	14.8	3.80	3.7	26	33	4.45
DR1050-180-R	17.5	3.39	3.3	33	41	4.09
DR1050-220-R	23.5	3.12	3.0	39	48	3.53
DR1050-270-R	26.9	2.82	2.8	43	53	3.30
DR1050-330-R	34.3	2.56	2.5	58	72	2.92
DR1050-390-R	38.3	2.35	2.35	61	76	2.77
DR1050-470-R	47.1	2.06	2.10	89	111	2.50
DR1050-560-R	56.7	1.96	1.94	98	123	2.27
DR1050-680-R	67.2	1.84	1.70	111	139	2.09
DR1050-820-R	84.4	1.60	1.58	147	184	1.86
DR1050-101-R	97.5	1.52	1.45	164	205	1.73
DR1050-121-R	118	1.30	1.30	223	279	1.57
DR1050-151-R	149	1.26	1.15	238	298	1.40
DR1050-181-R	184	1.18	1.08	273	341	1.26
DR1050-221-R	222	1.00	0.98	377	472	1.15
DR1050-271-R	264	0.96	0.90	410	513	1.06
DR1050-331-R	321	0.83	0.80	554	693	0.96
DR1050-391-R	397	0.76	0.72	648	810	0.86
DR1050-471-R	481	0.64	0.62	855	1069	0.78
DR1050-561-R	573	0.62	0.60	970	1213	0.72
DR1050-681-R	708	0.56	0.55	1095	1369	0.64
DR1050-821-R	819	0.54	0.50	1185	1481	0.60
DR1050-102-R	1000	0.43	0.48	1528	1950	0.54

1. Open Circuit Inductance (OCL) Test Parameters: 100 kHz, 0.1 Vrms, 0.0 Adc, +25 °C

2. I_{DC}: DC current for an approximate temperature rise of 40 °C without core loss. Derating is necessary for AC currents.

PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed 125 °C under worst case operating conditions verified in the end application.

3. I_{pk}: Peak current for approximately 35% rolloff @ +25 °C

4. K-factor: K-factor: Used to determine Bp-p for core loss (see graph). Bp-p = K * L * ΔI. Bp-p: (mT), K: (K-factor from table), L: (Inductance in μH), ΔI (Peak to peak ripple current in Amps).

5. Part Number Definition: DR1050-xxx-R

DR1050 = Product code and size

-xxx= inductance value in μH, R= decimal point,

If no R is present then last character equals number of zeros

-R suffix = RoHS compliant

Technical drawing of the 1000mAh battery showing front, top, and side views with dimensions:

- Front View:** Shows a circular battery with a diameter of 10.3 max. The height is 10.5 max. The top surface is labeled "XXX wuffy R". The bottom surface is labeled "2".
- Top View:** Shows a rectangular battery with a width of 5.0 max.
- Side View:** Shows the battery's profile, indicating a thickness of 5.0 max.

A diagram of a stepped profile. It consists of a horizontal base of length 3.3, a vertical step of height 1.6, and a top horizontal segment of length 3.3. The total height from the base to the top of the step is 7.3.

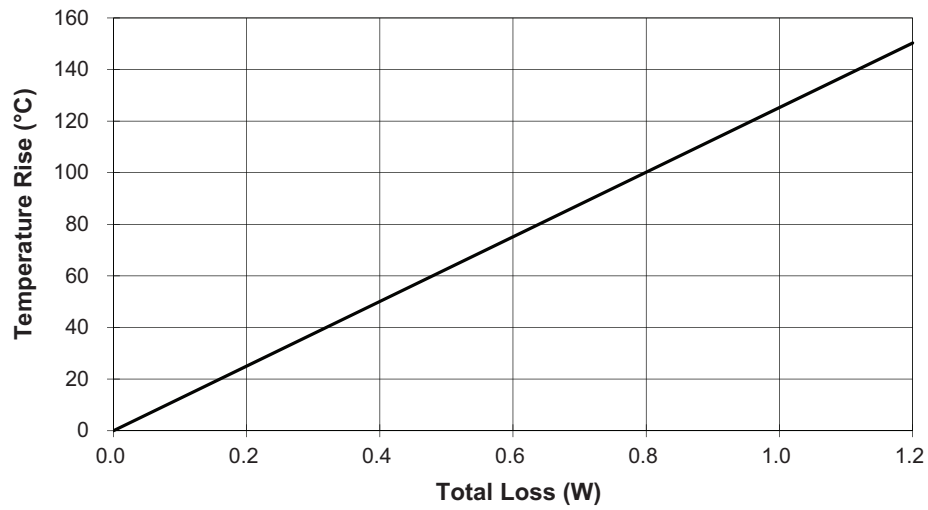
A schematic diagram of a transformer. The primary winding consists of a single loop with terminals labeled '1' and '2'. The secondary winding consists of two loops with terminals labeled '3' and '4'. The transformer core is represented by two vertical lines on the right side.

SECTION A-A

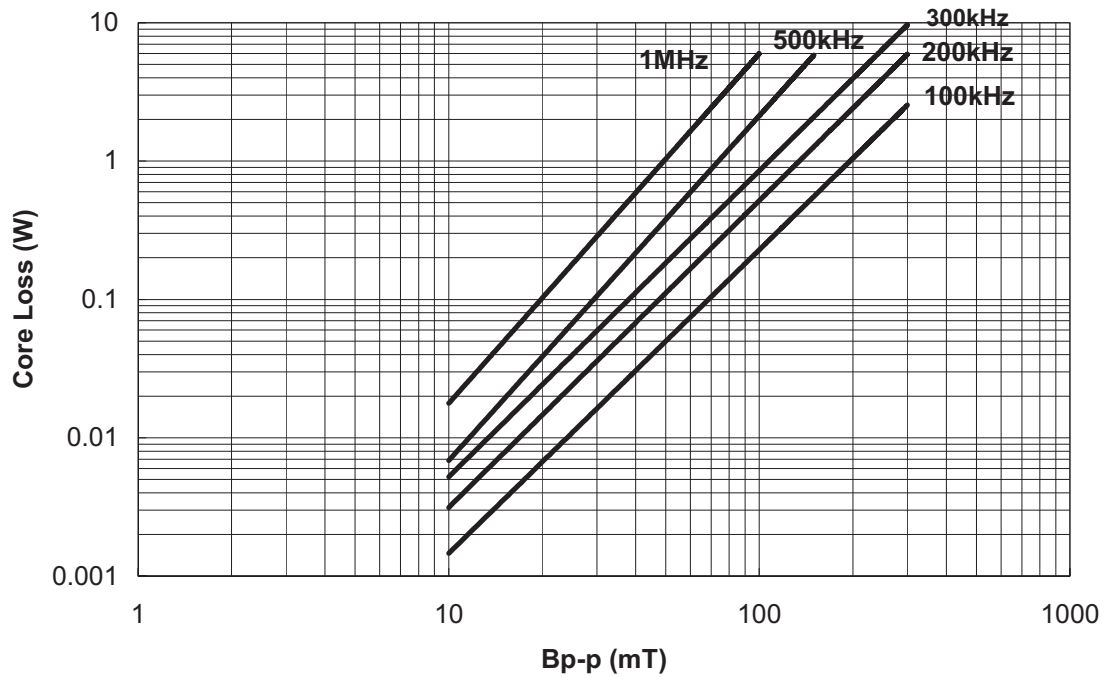
$A_1 = 10.5$
 $B_1 = 10.7$
 $K_0 = 5.5$

User direction of feed →

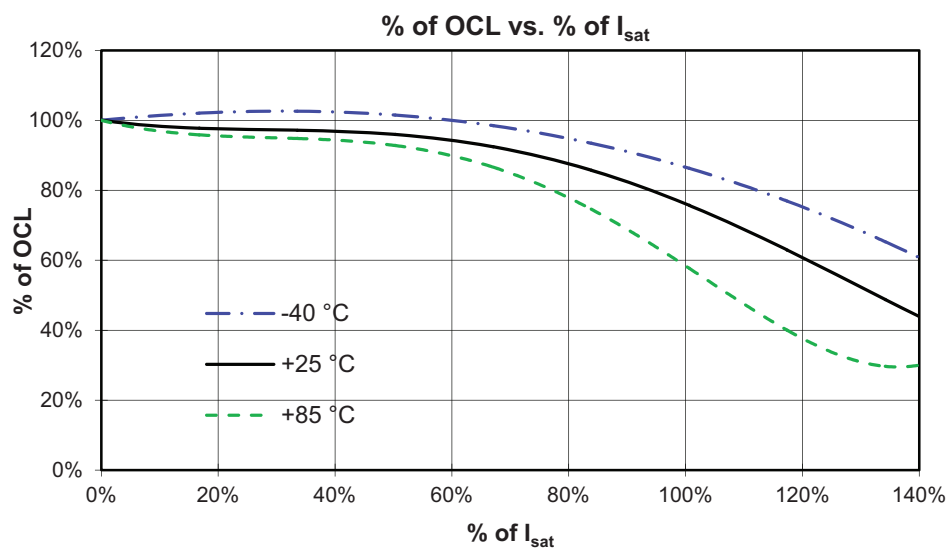
Temperature rise vs. total loss



Core loss vs. B_{p-p}



Inductance characteristics



Solder reflow profile

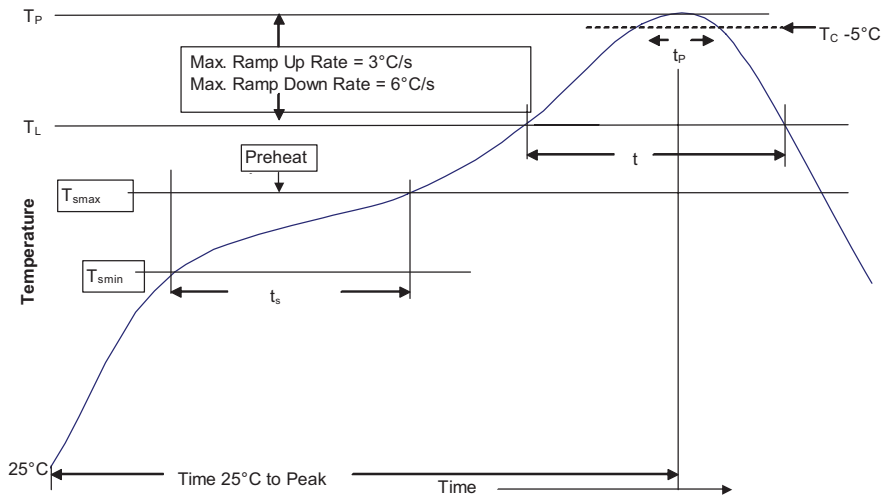


Table 1 - Standard SnPb Solder (T_C)

Package Thickness	Volume mm ³ <350	Volume mm ³ ≥350
<2.5mm)	235°C	220°C
≥2.5mm	220°C	220°C

Table 2 - Lead (Pb) Free Solder (T_C)

Package Thickness	Volume mm ³ <350	Volume mm ³ 350 - 2000	Volume mm ³ >2000
<1.6mm	260°C	260°C	260°C
1.6 – 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

Reference JEDEC J-STD-020D

Profile Feature	Standard SnPb Solder	Lead (Pb) Free Solder
Preheat and Soak		
• Temperature min. (T_{smin})	100°C	150°C
• Temperature max. (T_{smax})	150°C	200°C
• Time (T_{smin} to T_{smax}) (t_s)	60-120 Seconds	60-120 Seconds
Average ramp up rate T_{smax} to T_P	3°C/ Second Max.	3°C/ Second Max.
Liquidous temperature (T_L)	183°C	217°C
Time at liquidous (t_L)	60-150 Seconds	60-150 Seconds
Peak package body temperature (T_P)*	Table 1	Table 2
Time (t_p)** within 5 °C of the specified classification temperature (T_C)	20 Seconds**	30 Seconds**
Average ramp-down rate (T_P to T_{smax})	6°C/ Second Max.	6°C/ Second Max.
Time 25°C to Peak Temperature	6 Minutes Max.	8 Minutes Max.

* Tolerance for peak profile temperature (T_P) is defined as a supplier minimum and a user maximum.

** Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.

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